



PATENT  
Attorney Docket No.: SAM-0313CIP

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Kyoung-woo Lee, *et al.*

Examiner: Nguyen, Ha T.

Serial No.: 10/625,007

Group Art Unit: 2812

Filing Date: July 23, 2003

Title: METHOD OF FABRICATING DUAL DAMASCENE INTERCONNECTIONS  
OF MICROELECTRONIC DEVICE USING HYBRID LOW K-DIELECTRIC  
AND CARBON-FREE INORGANIC FILLER


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Stacy Sedlak

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Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

AMENDMENT A

Sir:

The following is in response to the Office Action dated June 2, 2005, and is filed within the shortened statutory period of three months. Please amend the application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 10 of this paper.